

# CD4020B, CD4024B, CD4040B Types

## CMOS Ripple-Carry Binary Counter/Dividers

High-Voltage Types (20-Volt Rating)

CD4020B – 14 Stage

CD4024B – 7 Stage

CD4040B – 12 Stage

■ CD4020B, CD4024B, and CD4040B are ripple-carry binary counters. All counter stages are master-slave flip-flops. The state of a counter advances one count on the negative transition of each input pulse; a high level on the RESET line resets the counter to its all zeros state. Schmitt trigger action on the input-pulse line permits unlimited rise and fall times. All inputs and outputs are buffered.

The CD4020B and CD4040B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4040B type also is supplied in 16-lead small-outline packages (M and M96 suffixes).

The CD4024B types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

### MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal) ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD}$  +0.5V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10\text{mA}$

POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A = -55^\circ\text{C}$  to  $+100^\circ\text{C}$  ..... 500mW

For  $T_A = +100^\circ\text{C}$  to  $+125^\circ\text{C}$  ..... Derate Linearly at 12mW/ $^\circ\text{C}$  to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$  ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) .....  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE ( $T_{stg}$ ) .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$

LEAD TEMPERATURE (DURING SOLDERING):

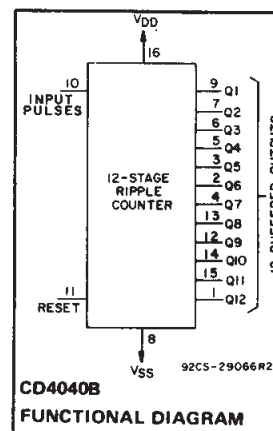
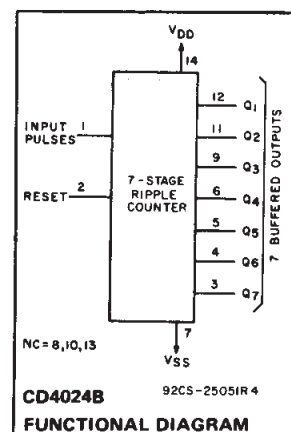
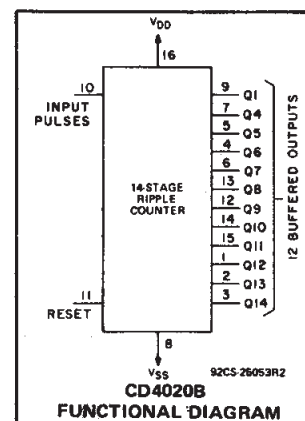
At distance  $1/16 \pm 1/32$  inch ( $1.59 \pm 0.79\text{mm}$ ) from case for 10s max .....  $+265^\circ\text{C}$

### Features:

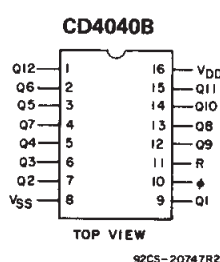
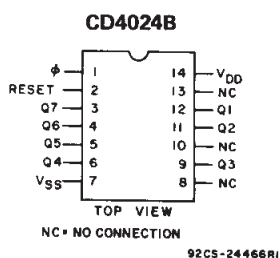
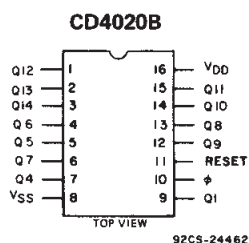
- Medium-speed operation
- Fully static operation
- Buffered inputs and outputs
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics
- Fully static operation
- Common reset
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of  $1\text{ }\mu\text{A}$  at 18 V over full package-temperature range;  $100\text{ nA}$  at 18 V and  $25^\circ\text{C}$
- Noise margin (over full package-temperature range):
  - 1 V at  $V_{DD} = 5\text{ V}$
  - 2 V at  $V_{DD} = 10\text{ V}$
  - 2.5 V at  $V_{DD} = 15\text{ V}$
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

### Applications:

- Control counters
- Frequency dividers
- Timers
- Time-delay circuits



### TERMINAL ASSIGNMENTS



## CD4020B, CD4024B, CD4040B Types

**RECOMMENDED OPERATING CONDITIONS** at  $T_A = 25^\circ\text{C}$ , Unless Otherwise Specified  
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                                                           | $V_{DD}$      | Min.              | Max.           | UNITS         |
|--------------------------------------------------------------------------|---------------|-------------------|----------------|---------------|
| Supply Voltage Range (at $T_A = \text{Full Package-Temperature Range}$ ) |               | 3                 | 18             | V             |
| Input-Pulse Frequency, $f_\phi$                                          | 5<br>10<br>15 | —<br>—<br>—       | 3.5<br>8<br>12 | MHz           |
| Input-Pulse Width, $t_W$                                                 | 5<br>10<br>15 | 140<br>60<br>40   | —<br>—<br>—    | ns            |
| Input-Pulse Rise or Fall Time, $t_{r\phi}, t_{f\phi}$                    | 5<br>10<br>15 | Unlimited         | —              | $\mu\text{s}$ |
| Reset Pulse Width, $t_W$                                                 | 5<br>10<br>15 | 200<br>80<br>60   | —              | ns            |
| Reset Removal Time, $t_{REM}$                                            | 5<br>10<br>15 | 350<br>150<br>100 | —              | ns            |

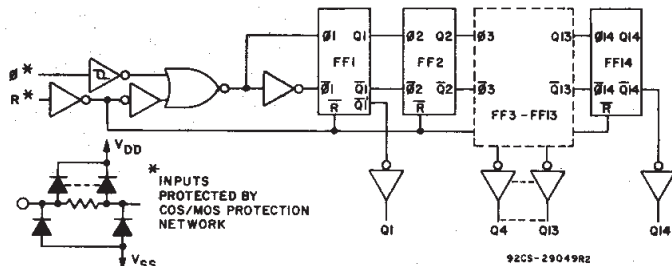


Fig. 1 — Logic diagram for CD4020B.

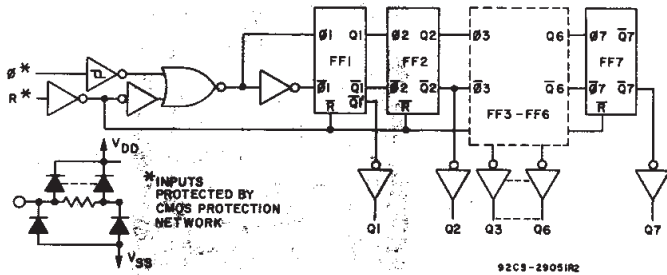


Fig. 2 — Logic diagram for CD4024B.

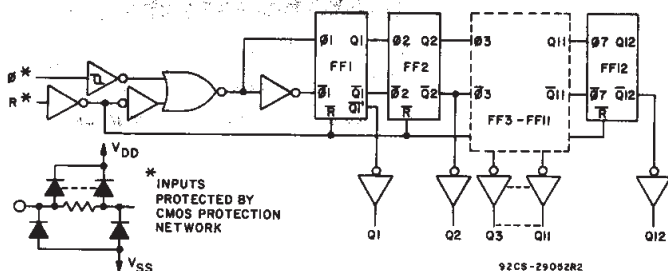


Fig. 3 — Logic diagram for CD4040B.

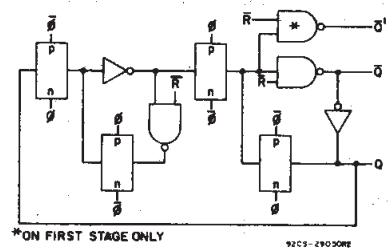


Fig. 4 — Detail of typical flip-flop stage.

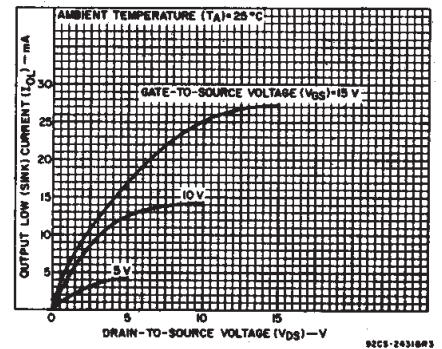


Fig. 5 — Typical output low (sink) current characteristics.

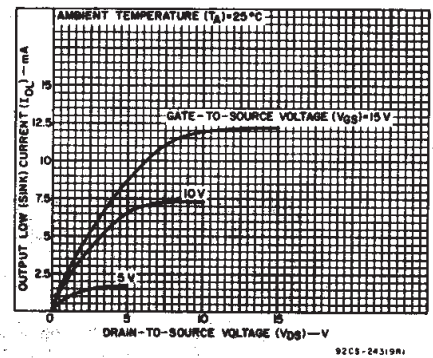


Fig. 6 — Minimum output low (sink) current characteristics.

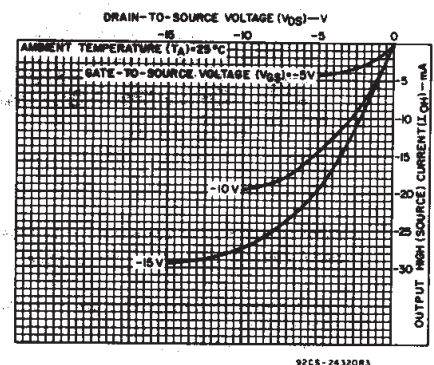


Fig. 7 — Typical output high (source) current characteristics.

# CD4020B, CD4024B, CD4040B Types

## STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-<br>ISTIC                                         | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNITS |
|-------------------------------------------------------------|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
|                                                             | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) | +25                                   |       |       |       |       |                   |      |       |
|                                                             |                       |                        |                        | -55                                   | -40   | +85   | +125  | Min.  | Typ.              | Max. |       |
| Quiescent Device<br>Current,<br>I <sub>DD</sub> Max.        | —                     | 0,5                    | 5                      | 5                                     | 5     | 150   | 150   | —     | 0.04              | 5    | μA    |
|                                                             | —                     | 0,10                   | 10                     | 10                                    | 10    | 300   | 300   | —     | 0.04              | 10   |       |
|                                                             | —                     | 0,15                   | 15                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |       |
|                                                             | —                     | 0,20                   | 20                     | 100                                   | 100   | 3000  | 3000  | —     | 0.08              | 100  |       |
| Output Low<br>(Sink) Current<br>I <sub>OL</sub> Min.        | 0.4                   | 0,5                    | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA    |
|                                                             | 0.5                   | 0,10                   | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |       |
|                                                             | 1.5                   | 0,15                   | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |       |
| Output High<br>(Source)<br>Current,<br>I <sub>OH</sub> Min. | 4.6                   | 0,5                    | 5                      | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | —    | mA    |
|                                                             | 2.5                   | 0,5                    | 5                      | -2                                    | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | —    |       |
|                                                             | 9.5                   | 0,10                   | 10                     | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | —    |       |
|                                                             | 13.5                  | 0,15                   | 15                     | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | —    |       |
| Output Voltage:<br>Low-Level,<br>V <sub>OL</sub> Max.       | —                     | 0,5                    | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V     |
|                                                             | —                     | 0,10                   | 10                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
|                                                             | —                     | 0,15                   | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
| Output Voltage:<br>High-Level,<br>V <sub>OH</sub> Min.      | —                     | 0,5                    | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    | V     |
|                                                             | —                     | 0,10                   | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |       |
|                                                             | —                     | 0,15                   | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |       |
| Input Low<br>Voltage,<br>V <sub>IL</sub> Max.               | 0.5, 4.5              | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  | V     |
|                                                             | 1, 9                  | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |       |
|                                                             | 1.5, 13.5             | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |       |
| Input High<br>Voltage,<br>V <sub>IH</sub> Min.              | 0.5, 4.5              | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    | V     |
|                                                             | 1, 9                  | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |       |
|                                                             | 1.5, 13.5             | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |       |
| Input Current<br>I <sub>IN</sub> Max.                       | —                     | 0,18                   | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>-5</sup> | ±0.1 | μA    |

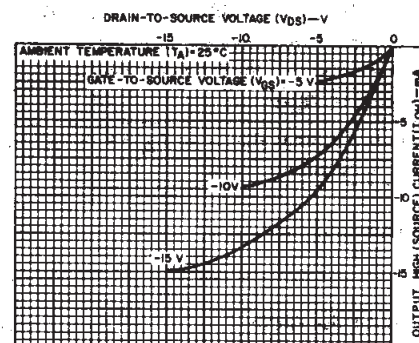


Fig. 8 — Minimum output high (source) current characteristics.

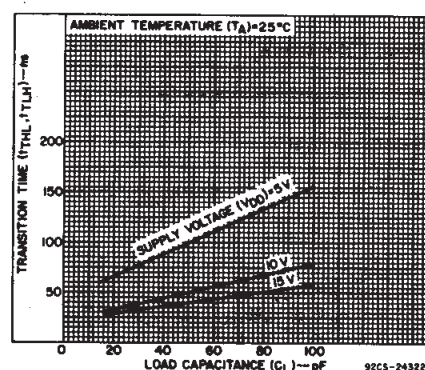
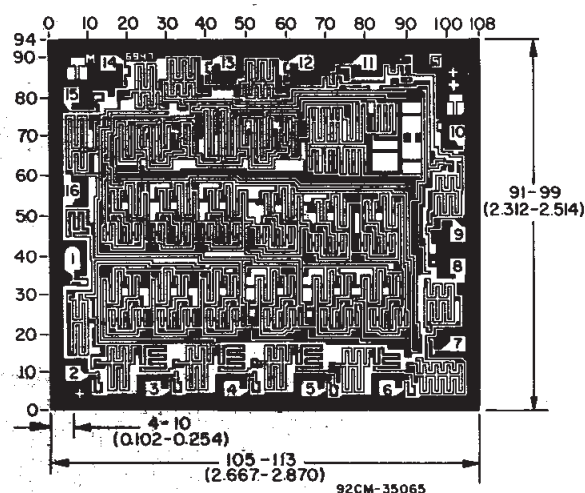
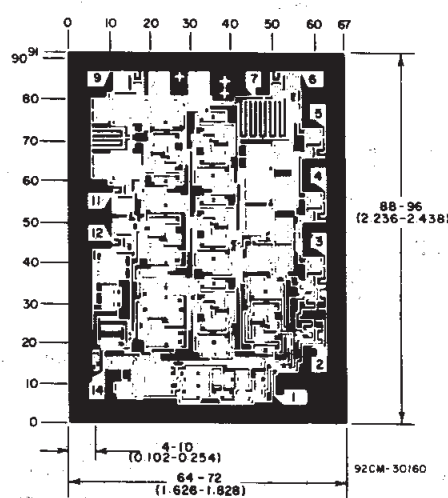


Fig. 9 — Typical transition time as a function of load capacitance.



Dimensions and Pad Layout for CD4020BH. Dimensions and pad layout for CD4040BH are identical.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).



Dimensions and Pad Layout for CD4024BH.

# CD4020B, CD4024B, CD4040B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20\text{ ns}$ ,  
 $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC                                                                               | TEST<br>CONDITIONS | V <sub>DD</sub><br>(V) | LIMITS    |      |      | UNITS |
|----------------------------------------------------------------------------------------------|--------------------|------------------------|-----------|------|------|-------|
|                                                                                              |                    |                        | Min.      | Typ. | Max. |       |
| Input-Pulse Operation                                                                        |                    |                        |           |      |      |       |
| Propagation Delay Time, $\phi$ to<br>Q <sub>1</sub> Out; t <sub>PHL</sub> , t <sub>PLH</sub> |                    | 5                      | —         | 180  | 360  | ns    |
|                                                                                              |                    | 10                     | —         | 80   | 160  |       |
|                                                                                              |                    | 15                     | —         | 65   | 130  |       |
| Q <sub>n</sub> to Q <sub>n</sub> + 1;<br>t <sub>PHL</sub> , t <sub>PLH</sub>                 |                    | 5                      | —         | 100  | 330  | ns    |
|                                                                                              |                    | 10                     | —         | 40   | 80   |       |
|                                                                                              |                    | 15                     | —         | 30   | 60   |       |
| Transition Time,<br>t <sub>THL</sub> , t <sub>TLH</sub>                                      |                    | 5                      | —         | 100  | 200  | ns    |
|                                                                                              |                    | 10                     | —         | 50   | 100  |       |
|                                                                                              |                    | 15                     | —         | 40   | 80   |       |
| Minimum Input-Pulse<br>Width, t <sub>W</sub>                                                 |                    | 5                      | —         | 70   | 140  | ns    |
|                                                                                              |                    | 10                     | —         | 30   | 60   |       |
|                                                                                              |                    | 15                     | —         | 20   | 40   |       |
| Input-Pulse Rise or Fall<br>Time, t <sub>rφ</sub> , t <sub>fφ</sub>                          |                    | 5                      | Unlimited |      |      | μs    |
|                                                                                              |                    | 10                     |           |      |      |       |
|                                                                                              |                    | 15                     |           |      |      |       |
| Maximum Input-Pulse<br>Frequency, f <sub>φ</sub>                                             |                    | 5                      | 3.5       | 7    | —    | MHz   |
|                                                                                              |                    | 10                     | 8         | 16   | —    |       |
|                                                                                              |                    | 15                     | 12        | 24   | —    |       |
| Input Capacitance, C <sub>I</sub>                                                            | Any Input          |                        | —         | 5    | 7.5  | pF    |
| Reset Operation                                                                              |                    |                        |           |      |      |       |
| Propagation Delay<br>Time, t <sub>PHL</sub>                                                  |                    | 5                      | —         | 140  | 280  | ns    |
|                                                                                              |                    | 10                     | —         | 60   | 120  |       |
|                                                                                              |                    | 15                     | —         | 50   | 100  |       |
| Minimum Reset Pulse<br>Width, t <sub>W</sub>                                                 |                    | 5                      | —         | 100  | 200  | ns    |
|                                                                                              |                    | 10                     | —         | 40   | 80   |       |
|                                                                                              |                    | 15                     | —         | 30   | 60   |       |
| Reset Removal Time,<br>t <sub>REM</sub>                                                      |                    | 5                      | —         | 175  | 350  | ns    |
|                                                                                              |                    | 10                     | —         | 75   | 150  |       |
|                                                                                              |                    | 15                     | —         | 50   | 100  |       |

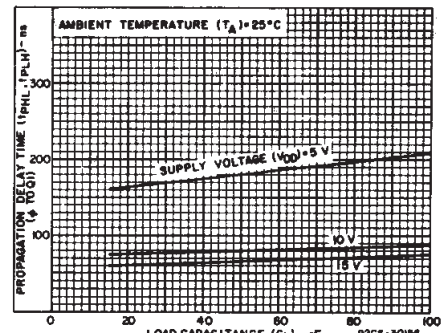


Fig. 10 - Typical propagation delay time as a function of load capacitance ( $\phi$  to  $Q_1$ ).

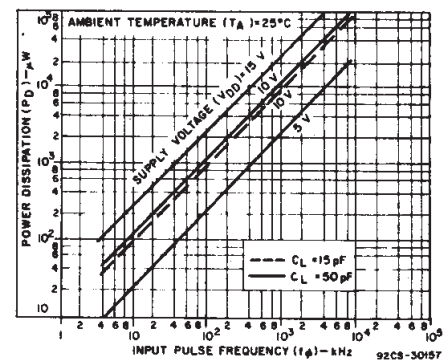


Fig. 11 - Typical dynamic power dissipation as a function of input pulse frequency for CD4020B.

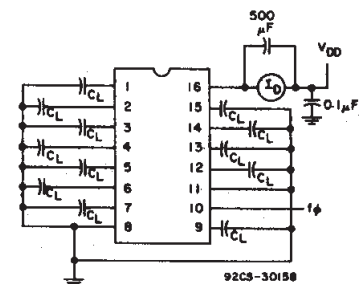


Fig. 12 - Dynamic power dissipation test circuit for CD4020B.

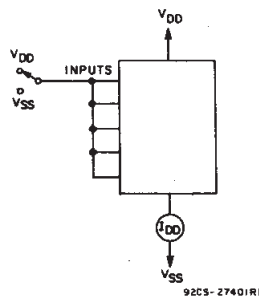


Fig. 13 - Quiescent device current test circuit.

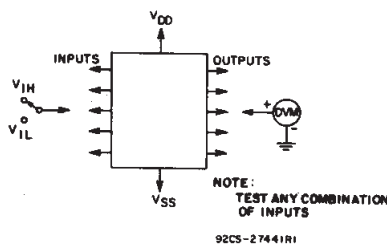


Fig. 14 - Input voltage test circuits.

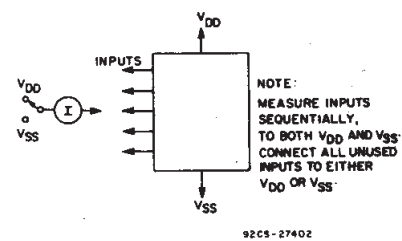


Fig. 15 - Input current test circuit.

**PACKAGING INFORMATION**

| Orderable part number      | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD4020BE</a>   | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4020BE            |
| CD4020BE.A                 | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4020BE            |
| CD4020BEE4                 | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4020BE            |
| <a href="#">CD4020BF</a>   | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4020BF            |
| CD4020BF.A                 | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4020BF            |
| <a href="#">CD4020BF3A</a> | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4020BF3A          |
| CD4020BF3A.A               | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4020BF3A          |
| <a href="#">CD4020BNSR</a> | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4020B             |
| CD4020BNSR.A               | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4020B             |
| <a href="#">CD4020BPW</a>  | Obsolete      | Production           | TSSOP (PW)   16 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CM020B              |
| <a href="#">CD4020BPWR</a> | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM020B              |
| CD4020BPWR.A               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM020B              |
| <a href="#">CD4024BE</a>   | Active        | Production           | PDIP (N)   14   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4024BE            |
| CD4024BE.A                 | Active        | Production           | PDIP (N)   14   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4024BE            |
| CD4024BEE4                 | Active        | Production           | PDIP (N)   14   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4024BE            |
| <a href="#">CD4024BF</a>   | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4024BF            |
| CD4024BF.A                 | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4024BF            |
| <a href="#">CD4024BF3A</a> | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4024BF3A          |
| CD4024BF3A.A               | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4024BF3A          |
| <a href="#">CD4024BM</a>   | Obsolete      | Production           | SOIC (D)   14   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CD4024BM            |
| <a href="#">CD4024BM96</a> | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4024BM            |
| CD4024BM96.A               | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4024BM            |
| <a href="#">CD4024BMT</a>  | Obsolete      | Production           | SOIC (D)   14   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CD4024BM            |
| <a href="#">CD4024BNSR</a> | NRND          | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4024B             |
| CD4024BNSR.A               | NRND          | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4024B             |
| <a href="#">CD4024BPW</a>  | Obsolete      | Production           | TSSOP (PW)   14 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CM024B              |
| <a href="#">CD4024BPWR</a> | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -55 to 125   | CM024B              |
| CD4024BPWR.A               | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM024B              |
| <a href="#">CD4040BE</a>   | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4040BE            |



| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)  |
|----------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|----------------------|
| CD4040BE.A                       | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4040BE             |
| CD4040BEE4                       | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4040BE             |
| <a href="#">CD4040BF</a>         | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4040BF             |
| CD4040BF.A                       | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4040BF             |
| <a href="#">CD4040BF3A</a>       | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4040BF3A           |
| CD4040BF3A.A                     | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4040BF3A           |
| <a href="#">CD4040BM</a>         | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040BM             |
| CD4040BM.A                       | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040BM             |
| <a href="#">CD4040BM96</a>       | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040BM             |
| CD4040BM96.A                     | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040BM             |
| <a href="#">CD4040BNSR</a>       | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040B              |
| CD4040BNSR.A                     | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4040B              |
| <a href="#">CD4040BPW</a>        | Obsolete      | Production           | TSSOP (PW)   16 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CM040B               |
| <a href="#">CD4040BPWR</a>       | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM040B               |
| CD4040BPWR.A                     | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM040B               |
| CD4040BPWRG4                     | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM040B               |
| <a href="#">JM38510/05653BEA</a> | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05653BEA |
| JM38510/05653BEA.A               | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05653BEA |
| <a href="#">JM38510/05655BCA</a> | NRND          | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05655BCA |
| JM38510/05655BCA.A               | NRND          | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05655BCA |
| <a href="#">M38510/05653BEA</a>  | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05653BEA |
| <a href="#">M38510/05655BCA</a>  | NRND          | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05655BCA |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

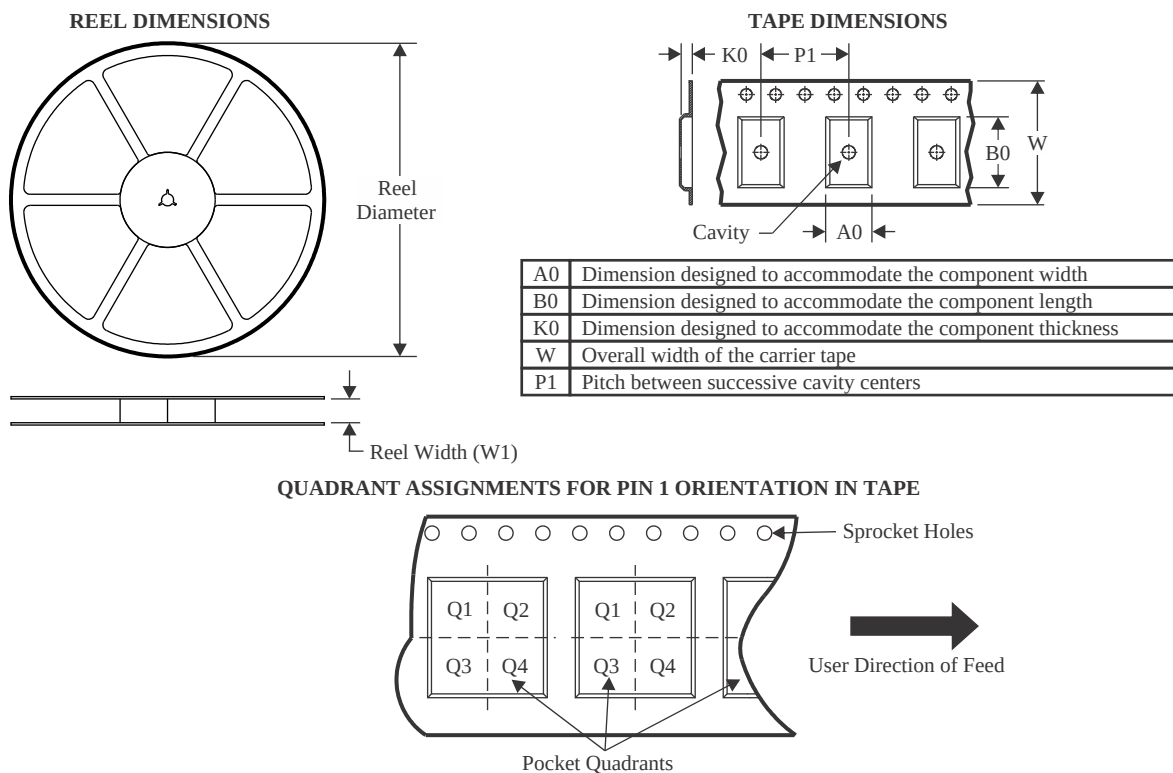
**OTHER QUALIFIED VERSIONS OF CD4020B, CD4020B-MIL, CD4024B, CD4024B-MIL, CD4040B, CD4040B-MIL :**

- Catalog : [CD4020B](#), [CD4024B](#), [CD4040B](#)
- Military : [CD4020B-MIL](#), [CD4024B-MIL](#), [CD4040B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION

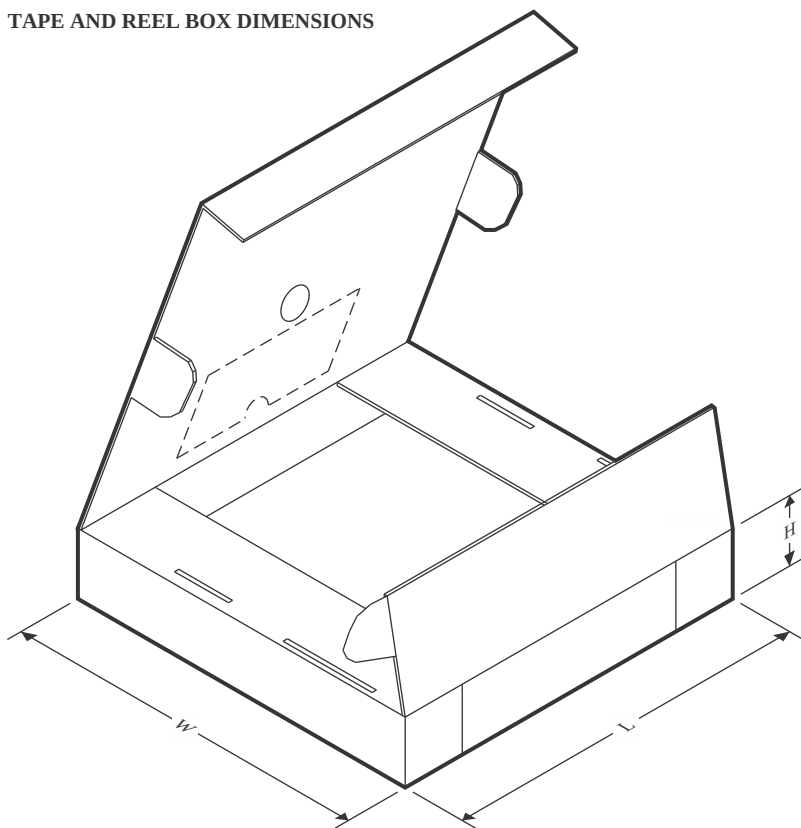


\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4020BNSR | SOP          | NS              | 16   | 2000 | 330.0              | 16.4               | 8.45    | 10.55   | 2.5     | 12.0    | 16.2   | Q1            |
| CD4020BPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| CD4024BM96 | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| CD4024BNSR | SOP          | NS              | 14   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4024BPWR | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| CD4040BM96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4040BNSR | SOP          | NS              | 16   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4040BPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

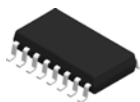


## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4020BNSR | SOP          | NS              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD4020BPWR | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD4024BM96 | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| CD4024BNSR | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| CD4024BPWR | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| CD4040BM96 | SOIC         | D               | 16   | 2500 | 353.0       | 353.0      | 32.0        |
| CD4040BNSR | SOP          | NS              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD4040BPWR | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |

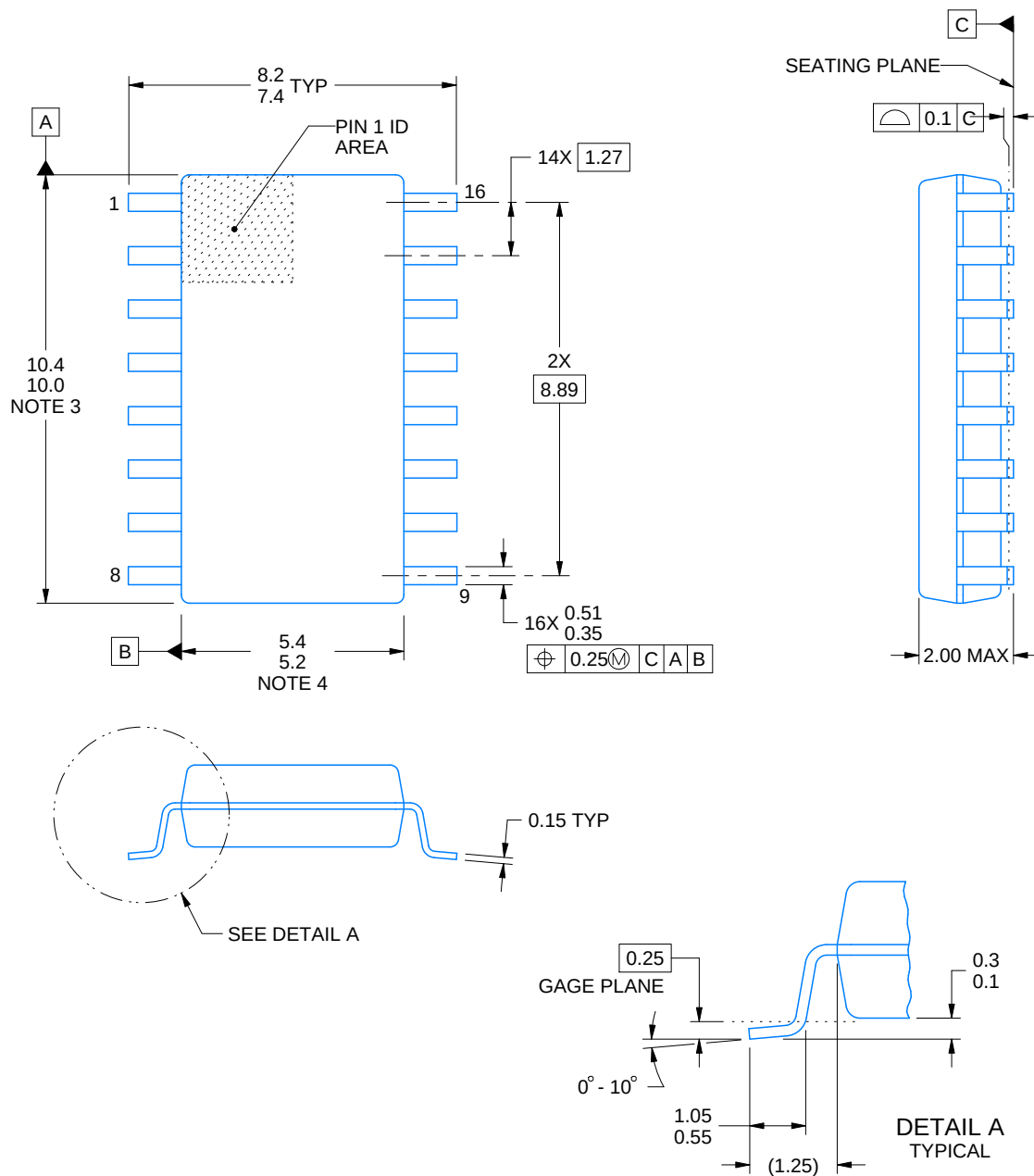


# PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



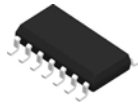
4220735/A 12/2021

## NOTES:

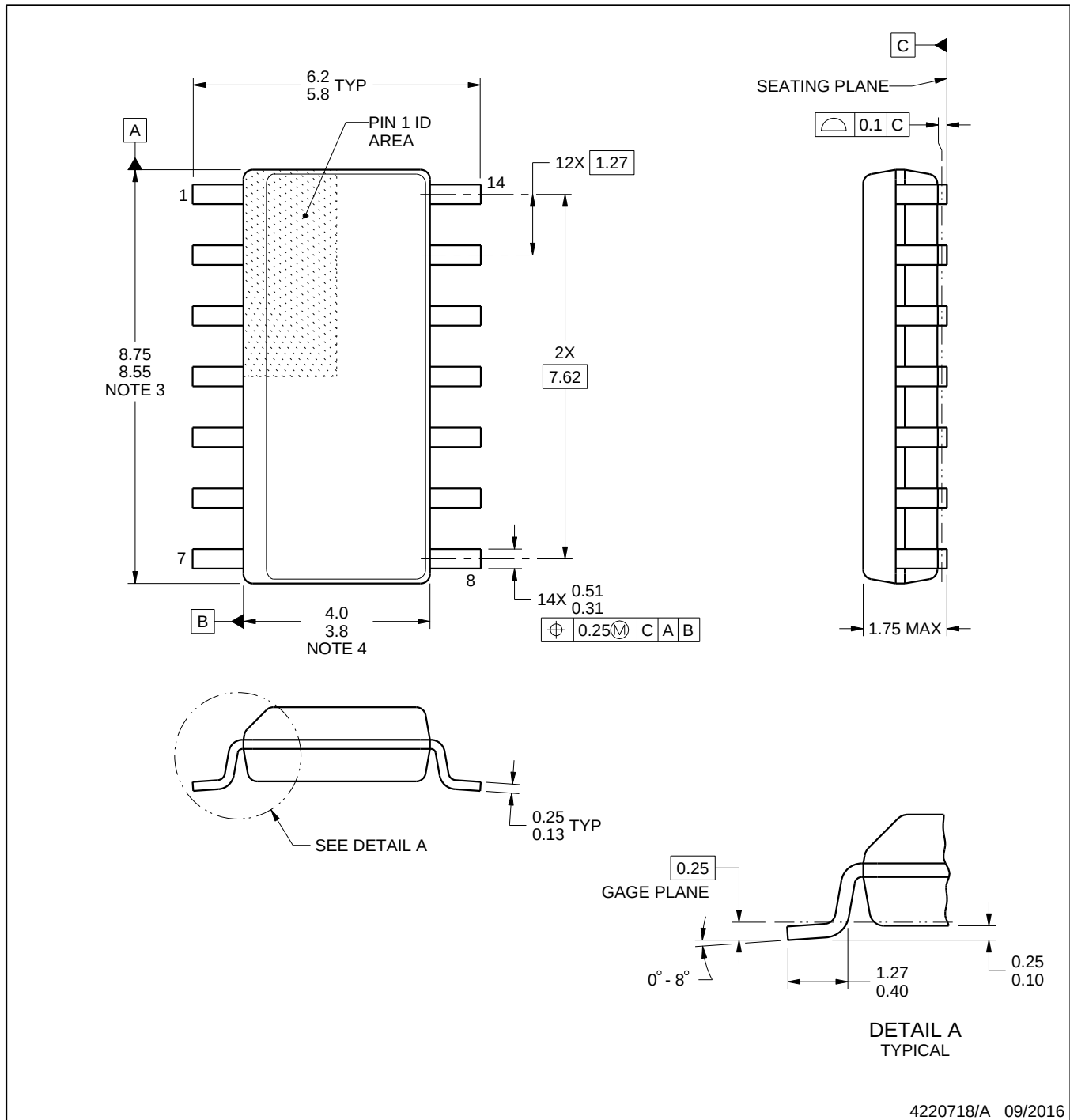
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.





**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT

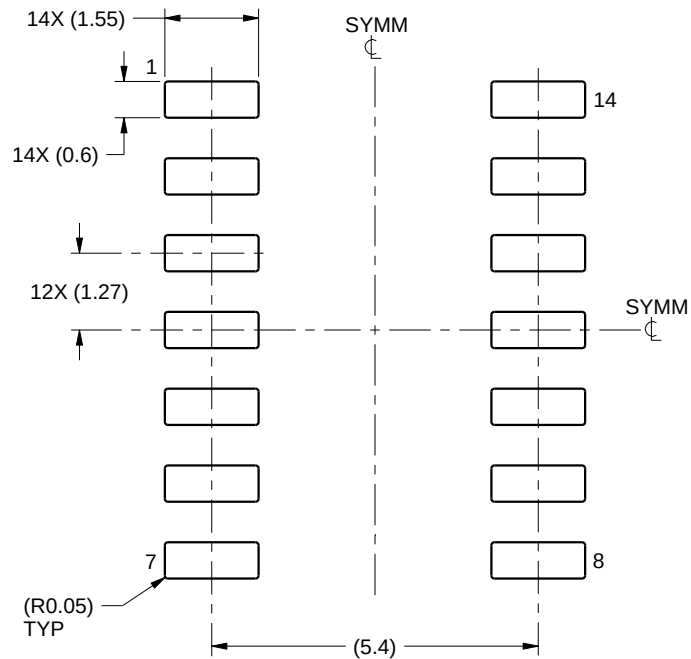


# EXAMPLE BOARD LAYOUT

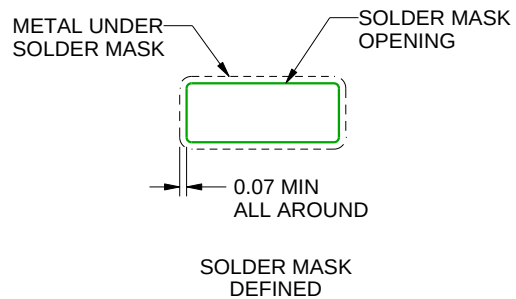
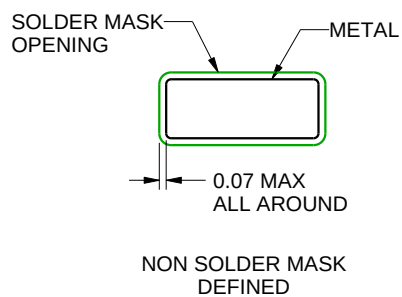
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

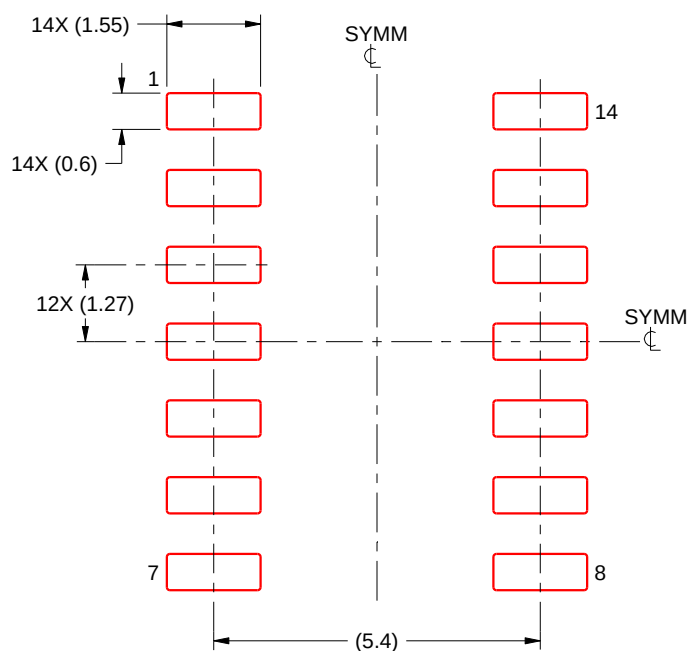


## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

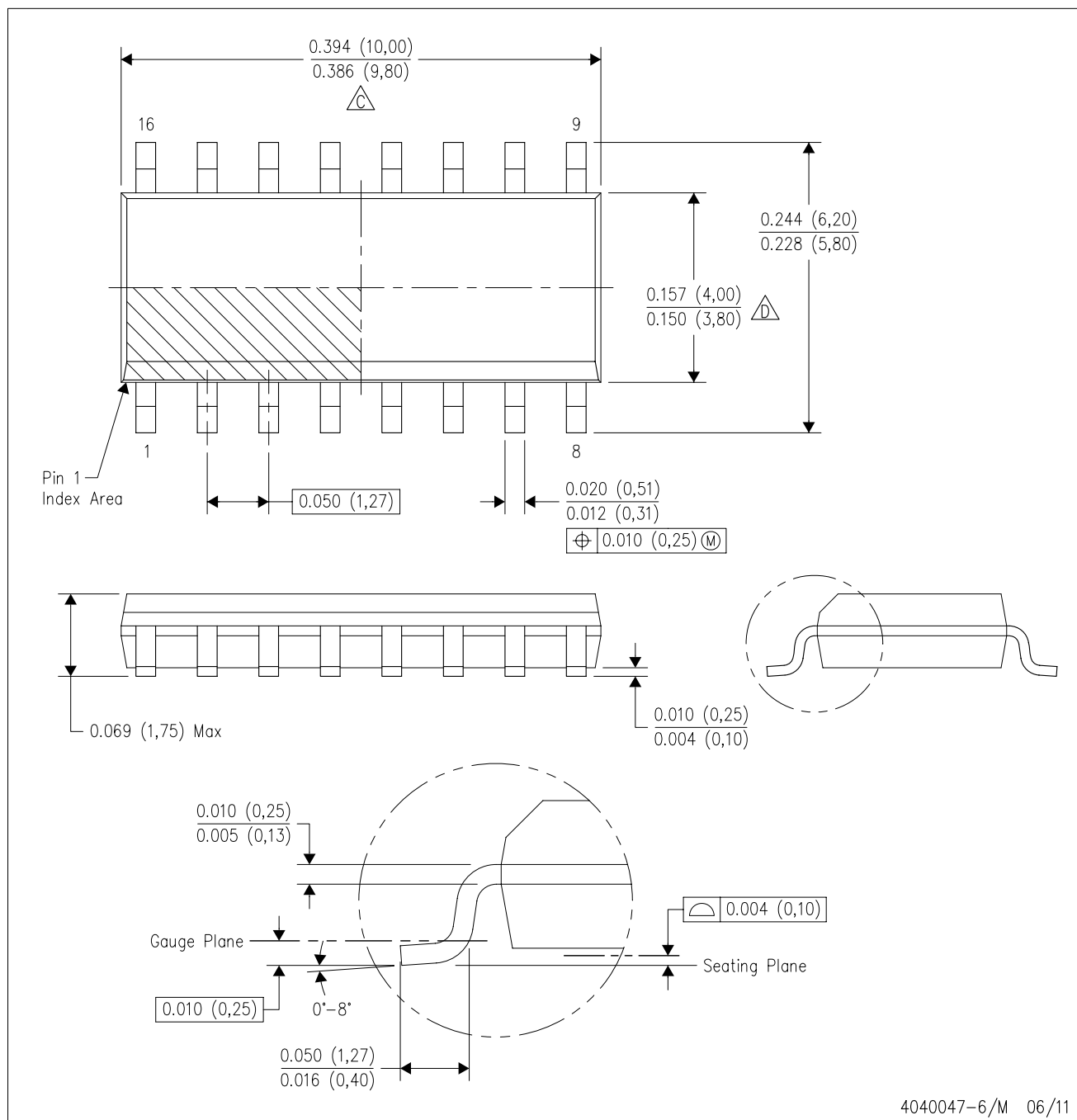
4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

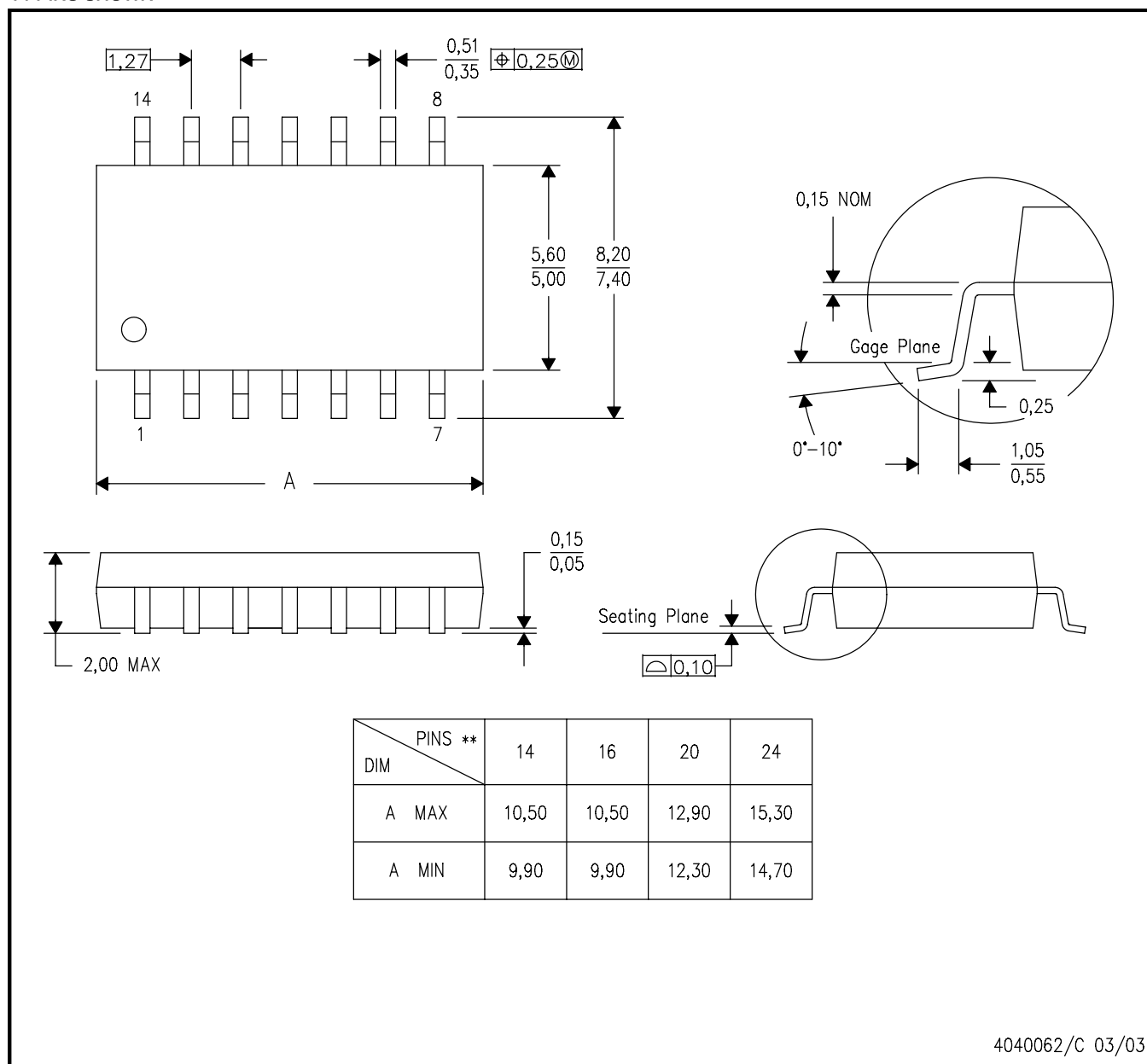
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

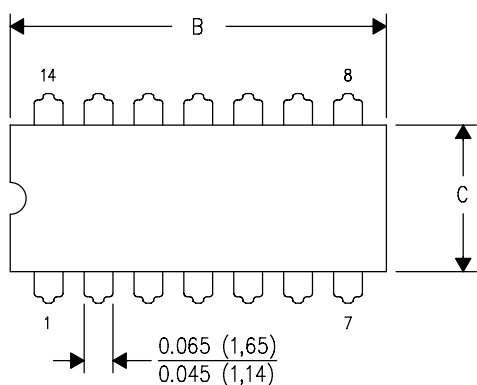


- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

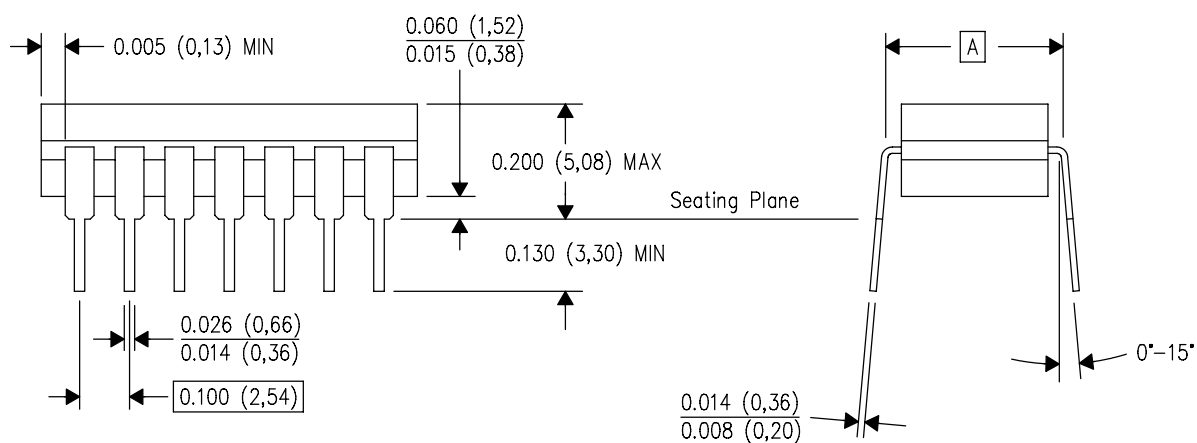
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

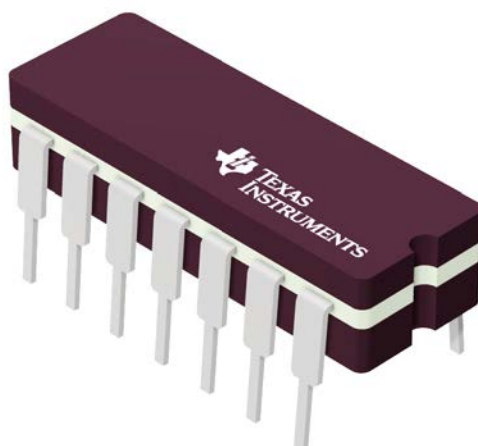
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

**J 14**

## GENERIC PACKAGE VIEW

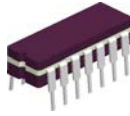
**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE

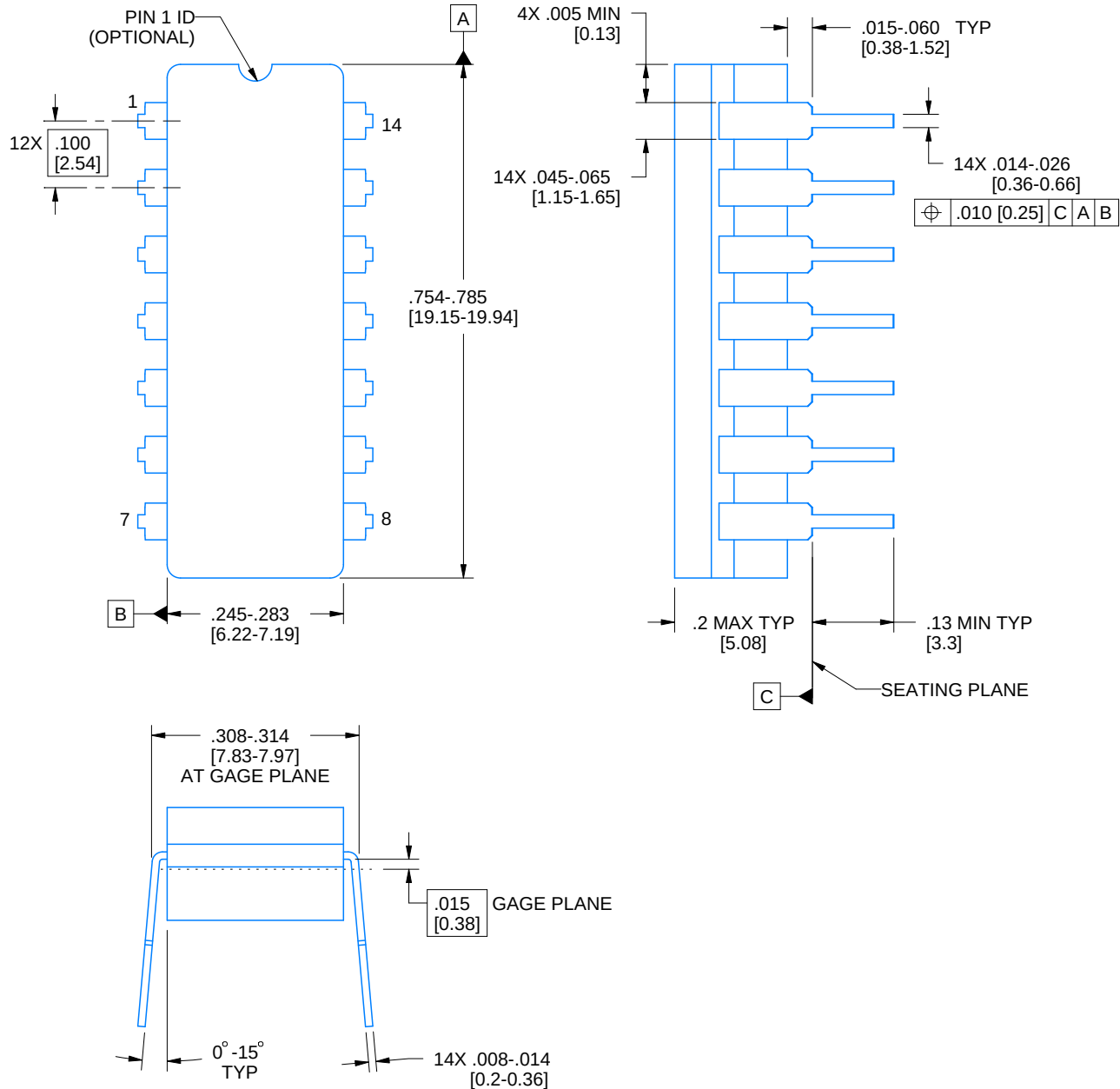


Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

**J0014A****PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

**NOTES:**

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.



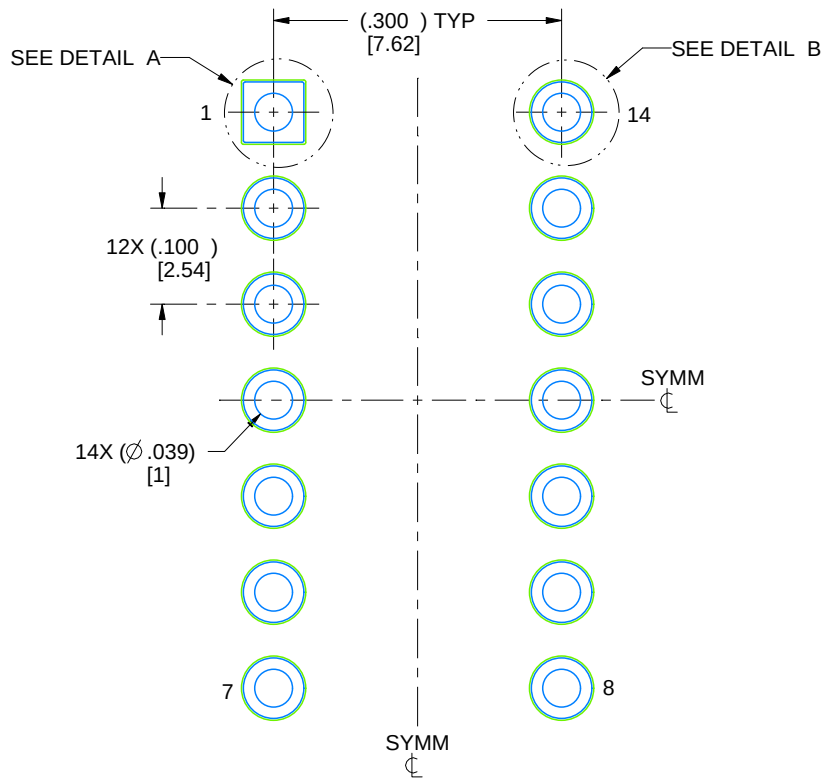
**TEXAS  
INSTRUMENTS**  
www.ti.com

# EXAMPLE BOARD LAYOUT

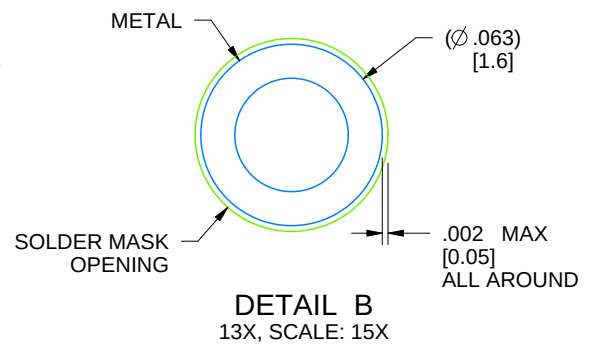
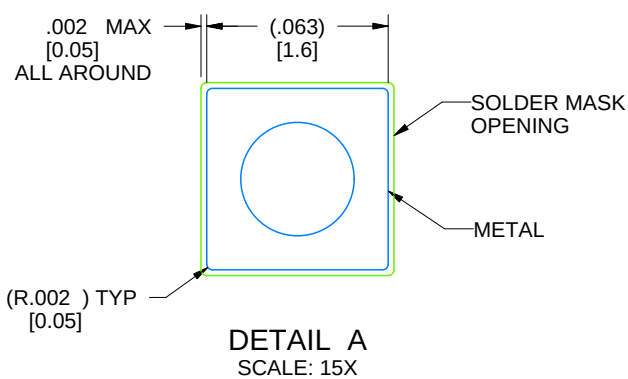
J0014A

CDIP - 5.08 mm max height

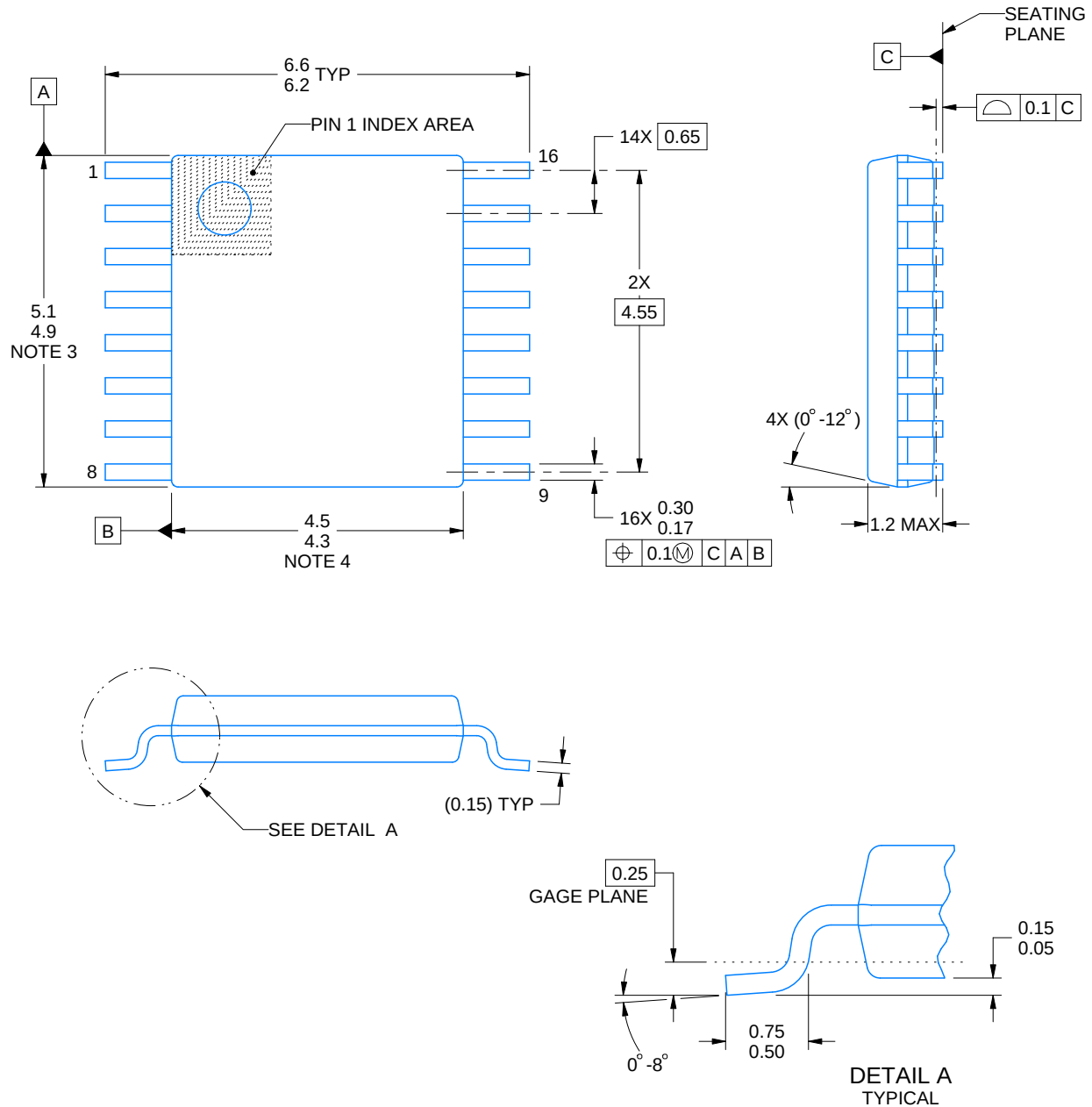
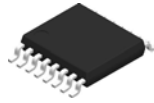
CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017



4220204/B 12/2023

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

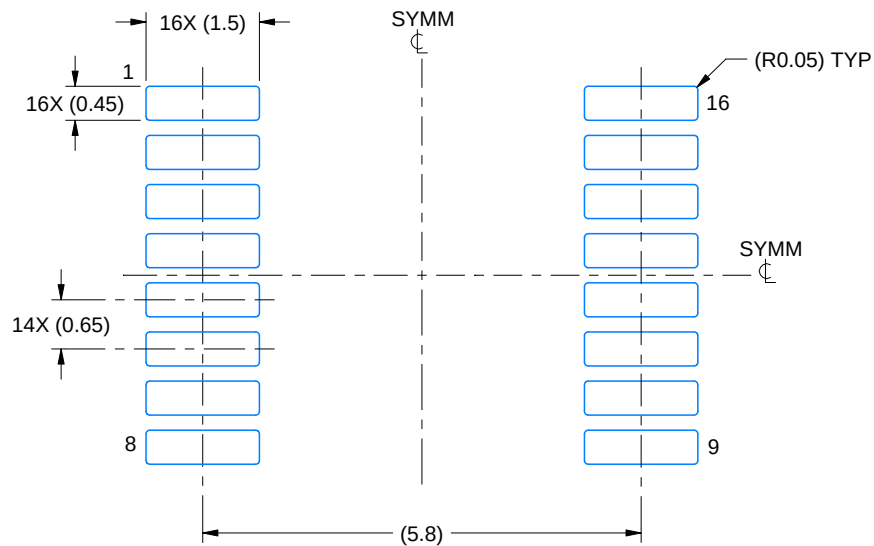


# EXAMPLE BOARD LAYOUT

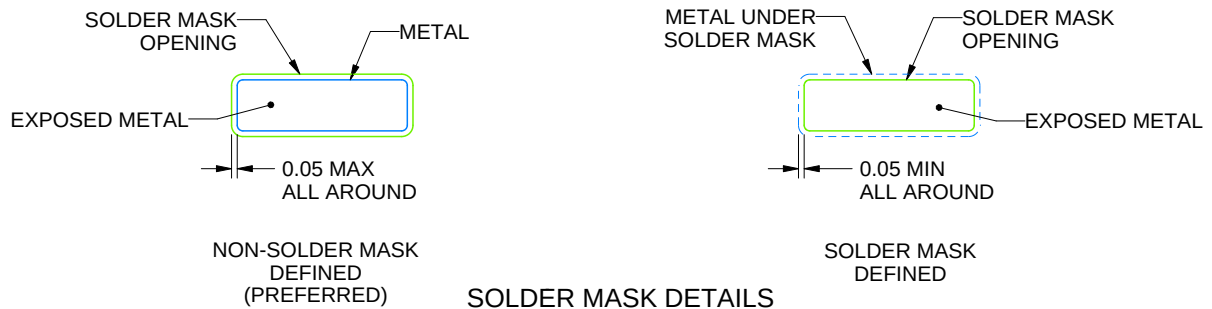
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

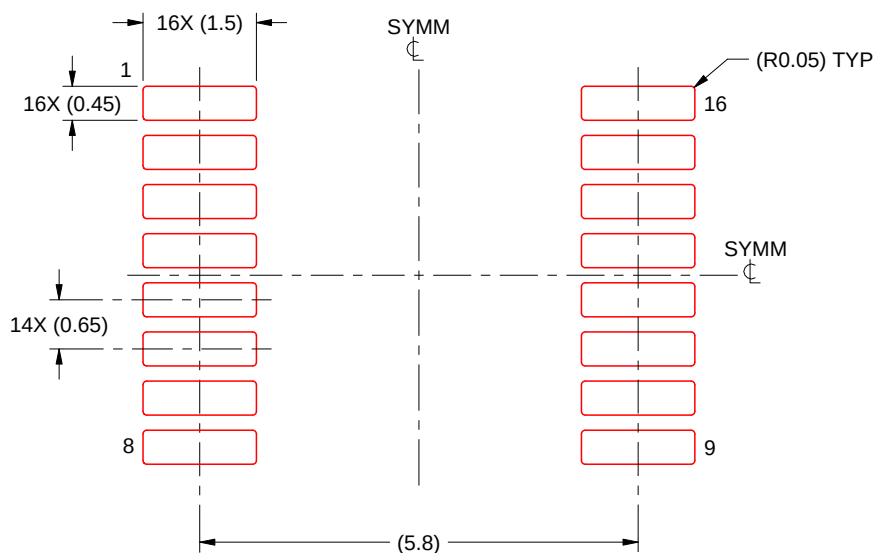
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/B 12/2023

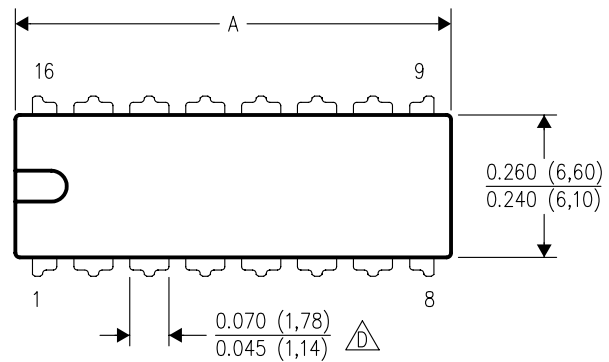
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

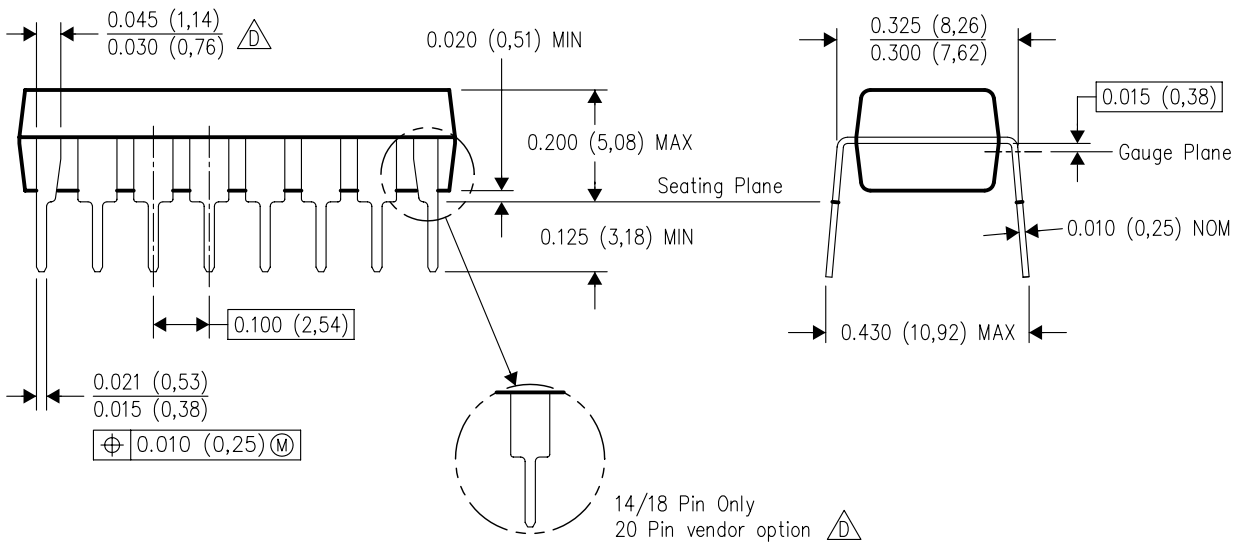
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

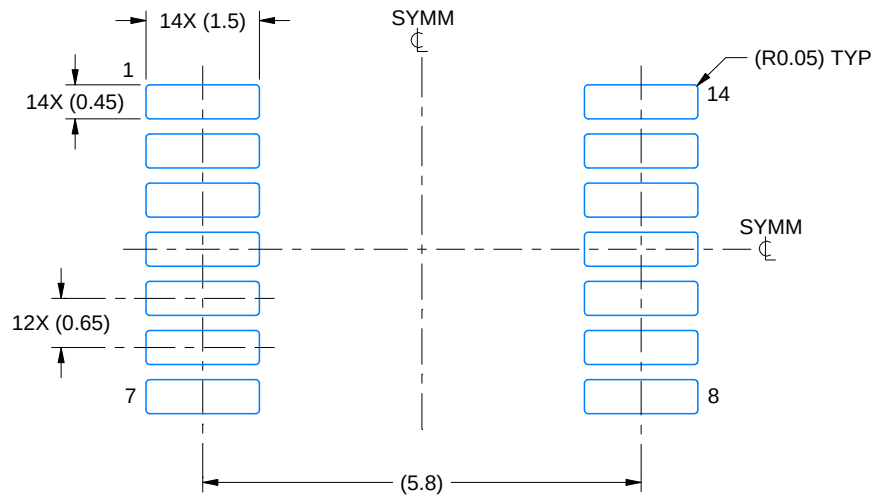


# EXAMPLE BOARD LAYOUT

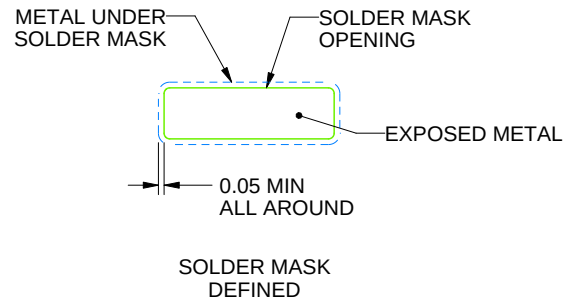
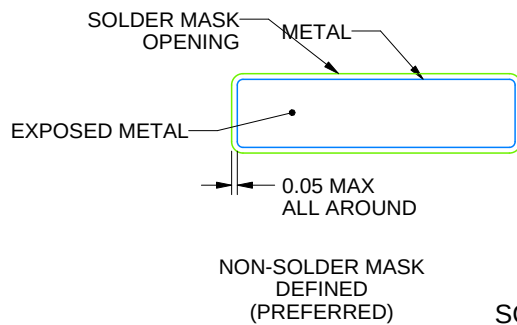
PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

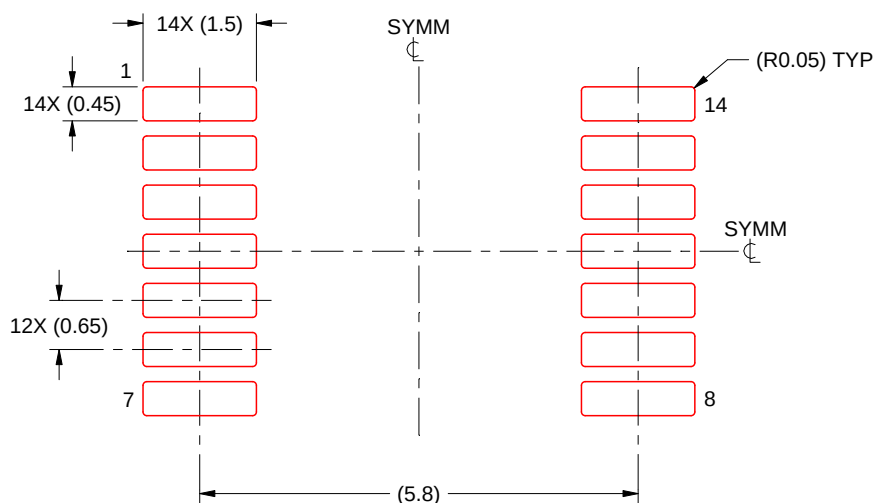
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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Last updated 10/2025